

FORM PTO-1449
(Rev. 7-80)U.S. Department of Commerce
Patent and Trademark OfficeAtty. Docket No.
TESSERA 3.0-109 CIP DIV

Application No.

LIST OF PRIOR ART CITED BY APPLICANT

(Use several sheets if necessary)

Applicant
Kim, et al.

Filing Date: February 2, 2001

Group

U.S. PATENT DOCUMENTS

*EXAMINER INITIALS		DOCUMENT NUMBER	DATE	NAME	CLASS	SUBCLASS	FILING DATE IF APPROPRIATE
<i>G</i>	AA	4,941,033	7/10/90	Kishida	357	75	
	AB	5,148,265	9/15/92	Khandros et al.	357	80	
	AC	5,148,266	9/15/92	Khandros et al.	357	80	
	AD	5,347,159	9/13/94	Khandros et al.	257	692	
	AE	5,390,844	2/21/95	DiStefano et al.	228	180.21	
	AF	5,398,863	3/21/95	Grube et al.	228	106	
	AG	5,491,302	2/13/96	DiStefano et al.	114	260	
	AH	5,536,909	7/16/96	DiStefano et al.	174	261	
	AI	5,646,446	7/8/97	Nicewarner, Jr. et al.	257	723	
	AJ	5,776,797	7/7/98	Nicewarner, Jr. et al.	438	107	
<i>G</i>	AK	5,861,666	1/19/99	Bellaar	257	686	

FOREIGN PATENT DOCUMENTS

		DOCUMENT NUMBER	DATE	COUNTRY	CLASS	SUBCLASS	TRANSLATION	
							YES	NO
<i>G</i>	AL	2 312 172		France				
<i>G</i>	AM	0 080 041 A2	06/83	Europe				
<i>G</i>	AN	WO 94/03036	02/94	WIPO				
	AO							
	AP							

OTHER PRIOR ART (Including Author, Title, Date, Pertinent Pages, Etc.)

<i>G</i>	AR	Bill Chou et al., "Ultra-High-Density Interconnect Flex Substrates", High Density Interconnects, 12/1998, pp. 14-21
<i>G</i>	AS	Rudolf Leutenbauer et al., "Development of a Top-Bottom BGA", High Density Interconnects, 12/1998, pp. 28-32
<i>G</i>	AT	Daryl Ann Doane and Paul D. Franzon, "Packaging Performance Factors," Multichip Module Technologies and Alternatives: The basics, pp. 109-112, ©1993 by Van Nostrand Reinhold.

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*EXAMINER: Initial if reference considered, whether or not citation is in conformance with MPEP 609; Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.

09/776356
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<i>Q</i>	AA	5,659,952	8/26/97	<i>Kovac et al.</i>	29	840	
	AB	3,214,827	11/65	Phohofsky	29	155.5	
	AC	3,775,844	12/73	Parks	29	626	
	AD	4,225,900	09/80	Ciccio et al.	361	395	
	AE	4,982,265	01/91	Watanabe et al.	357	75	
	AF	5,046,238	09/91	Daigle et al.	29	830	
	AG	5,138,438	08/92	Masayuki et al.	357	75	
	AH	5,172,303	12/92	Bernardoni et al.	361	396	
	AI	5,198,888	03/93	Sugano et al.	257	686	
	AJ	5,222,014	06/93	Lin	361	414	
<i>Q</i>	AK	5,247,423	09/93	Lin et al.	361	719	

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							YES	NO
	AL							
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	AN							
	AO							
	AP							

OTHER PRIOR ART (Including Author, Title, Date, Pertinent Pages, Etc.)

	AR	N. Senba et al., "Application of 3-Dimensional Memory Module," ISHM 1996 Proceedings, pp. 279-284.
	AS	
	AT	

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	AA	5,281,852	01/94	Normington	257	685	
	AB	5,334,875	08/94	Sugano et al.	257	686	
	AC	5,397,916	03/95	Normington	257	686	
	AD	5,422,435	06/95	Takiar et al.	174	52.4	
	AE	5,426,563	06/95	Moresco et al.	361	689	
	AF	5,440,171	08/95	Miyano et al.	257	700	
	AG	5,454,160	10/95	Nickel	29	840	
	AH	5,455,740	10/95	Burns	361	735	
	AI	5,479,318	12/95	Burns	361	735	
	AJ	5,489,749	02/96	DiStefano et al.	174	261	
	AK	5,659,952	08/97	Kovac et al.	29	840	

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